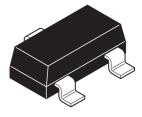


ZXTP5401FL 150V, SOT23, PNP High voltage transistor

Summary

BV_{CEO} > -150V BV_{EBO} > -5V I_{C(cont)} = -600mA P_D = 330mW Complementary part number ZXTN5551FL



Description

A high voltage PNP transistor in a small outline surface mount package.

Features

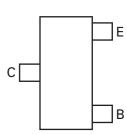
- 150V rating
- SOT23 package

Applications

• High voltage amplification

Ordering information

Device	Reel size	Tape width	Quantity
	(inches)	(mm)	per reel
ZXTP5401FLTA	7	8	3000



Pinout - top view

Device marking

P01

Absolute maximum ratings

Parameter	Symbo	l Limit	Unit
Collector-base voltage	V _{CBO}	-160	V
Collector-emitter voltage	V _{CEO}	-150	V
Emitter-base voltage	V _{EBO}	-5	V
Continuous collector current ^(a)	Ι _C	-600	mA
Pulsed collector current	I _{CM}	-1	А
Power dissipation at $T_{amb} = 25^{\circ}C^{(a)}$	P _D	330	mW
Linear derating factor		2.64	mW/°C
Operating and storage temperature range	T _j , T _{stg}	-55 to 150	°C

Thermal resistance

Parameter	Symbol	Limit	Unit
Junction to ambient ^(a)	R_{\ThetaJA}	379	°C/W

NOTES:

(a) For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz weight copper, in still air conditions.

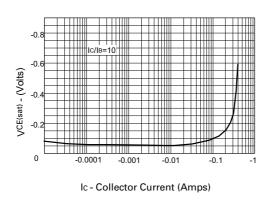
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Collector-base breakdown voltage	BV _{CBO}	-160	-270		V	I _C = -100μA
Collector-emitter breakdown voltage (base open)	BV _{CEO}	-150	-240		V	I _C = -1mA ^(*)
Emitter-base breakdown voltage	BV _{EBO}	-5	-8.1		V	I _E = -10μA
Collector cut-off current	I _{CBO}		<-1	-50	nA	V _{CB} = -120V
				-50	μA	$V_{CB} = -120V, T_{amb} = 100^{\circ}C$
Collector-emitter	V _{CE(sat)}		-50	-200	mV	I _C = -10mA, I _B = -1mA ^(*)
saturation voltage			-70	-500	mV	I _C = -50mA, I _B = -5mA ^(*)
Base-emitter saturation	$V_{BE(sat)}$		-700	1000	mV	I _C = -10mA, I _B = -1mA ^(*)
voltage			-750	1000	mV	l _C = -50mA, l _B = -5mA ^(*)
Static forward current	h _{FE}	50	135			$I_{C} = -1mA, V_{CE} = -5V^{(*)}$
transfer ratio		60	135	240		$I_{C} = -10 \text{mA}, V_{CE} = -5 V^{(*)}$
		50	130			$I_{C} = -50 \text{mA}, V_{CE} = -5 V^{(*)}$
Transition frequency	f _T		100		MHz	I _C = -10mA, V _{CE} = -10V f = 100MHz
Output capacitance	C _{OBO}			10	pF	V _{CB} = -10V, f = 1MHz ^(*)
Delay time	t _(d)		386		ns	V _{CC} = -50V. I _C = 100mA,
Rise time	t _(r)		202		ns	I _{B1} = I _{B2} = -10mA.
Storage time	t _(s)		1720		ns]
Fall time	t _(f)		275		ns	

Electrical characteristics (at T_{amb} = 25°C unless otherwise stated)

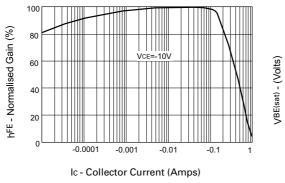
NOTES:

(*) Measured under pulsed conditions. Pulse width ${\leq}300\mu s;$ duty cycle ${\leq}2\%.$

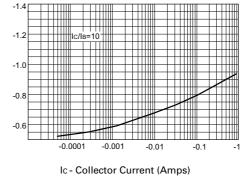
Typical characteristics



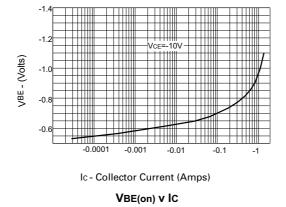
VCE(sat) v IC



hFE v IC



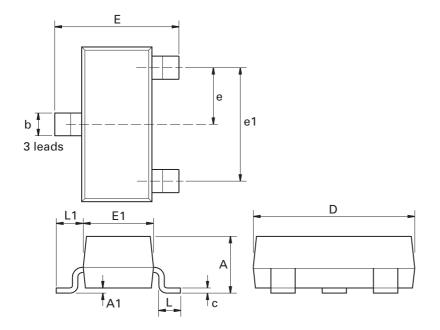
VBE(sat) v IC



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Package outline - SOT23



Dim.	Millin	neters	Inc	hes	Dim.	Millimeters		Inches	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
А	-	1.12	-	0.044	e1	1.90	NOM	0.075	NOM
A1	0.01	0.10	0.0004	0.004	E	2.10	2.64	0.083	0.104
b	0.30	0.50	0.012	0.020	E1	1.20	1.40	0.047	0.055
С	0.085	0.20	0.003	0.008	L	0.25	0.60	0.0098	0.0236
D	2.80	3.04	0.110	0.120	L1	0.45	0.62	0.018	0.024
е	0.95	NOM	0.037	NOM	-	-	-	-	-

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

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Issue 1 - August 2007

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